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EFS ID:

42870

Application ID:

10020207

Ball Grid Array Package

Title of Invention:

Substrates and Method of

Making the Same

First Named Inventor:

Reza-Ur Khan

Domestic/Foreign Application:

Domestic Application

Filing Date:

2001-12-18

Effective Receipt Date:

2003-07-02

Submission Type:

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Statement

Filing Type:

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7969

Attorney Docket Number:

1875.1640000

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Title of Invention

Ball Grid Array Package Substrates and Method of Making the Same

Application Number:

10/020207

Date:

2001-12-18

First Named Applicant:

Reza-Ur Khan

Confirmation Number:

7969

Attorney Docket Number: 1875.1640000

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> Title of Invention

Ball Grid Array Package Substrates and Method of Making the Same

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Application Number:

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First Named Applicant:

Reza-Ur Khan

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Search string:

(5045921 or 5291062 or 5397917 or 5490324 or 5572405 or 5583377 or 5583378 or 3790866 or 5578869 or 5642261 or 5648679 or 5691567 or 5736785 or 5798909 or 5835355 or 5844168 or 5883430 or 5889324 or 5894410 or 5901041 or 5903052 or 5905633 or 5953589 or 5972734 or 5977626 or 5986885 or 5998241 or 6002169 or 6011304 or 6028358 or 6077724 or 6084777 or 6114761 or 6117797 or 6122171 or 6133064 or 6140707 or 6160705 or 6162659 or 6163458 or 6166434 or 6184580 or 6212070 or 6380623 or 6347037 or 6362525 or 5801432 or 5438216

or 6069407 or 20010045644 or

20020109226).pn.

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Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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Examiner Name	Date